

TESCAN Announces 2021 Spring Seminar Series for Electron Microscopy and Micro-Computed Tomography Users

Brno, Czech Republic, March 2, 2021

Seminar series will cover new technology, techniques and applications in the geosciences, materials sciences, additive manufacturing, life sciences and semiconductor industries.

TESCAN ORSAY HOLDING a.s. announces a new 2021 Spring Seminar Series for electron microscopy and micro-computed tomography (micro-CT) users worldwide. The free, 12-seminar series will take place weekly, starting March 3 through May 19, 2021, and will feature leading technology & applications experts who will present on important topics in the geosciences, materials science, life sciences and semiconductor industries.

“TESCAN is launching this new Spring Seminar Series as a way to keep our current and potential customers up-to-date with the latest technology, techniques, and applications,” said Maroš Karabinoš, Global Marketing Director, TESCAN. *“Each online seminar will be instructed by a market segment expert. The series will feature topics on automated mineralogy, additive manufacturing, semiconductor failure analysis, lamella preparation for biological sciences, efficient multi-sample workflow solutions, and more. We carefully selected the topics and ‘best practices’ that we feel are important to share in an effort to help our customers succeed.”*

Spring Seminar Series At-a-Glance:

March 3, 2021	Invitation to Celebrate Paul Gottlieb’s Career and Contributions in Automated Mineralogy
March 10, 2021	Efficient Analytical Workflows with TESCAN’s VEGA & MIRA SEMs
March 17, 2021	Micro-CT and Additive Manufacturing: Moving from 3D to 4D
March 24, 2021	Speed mm-scale Semiconductor Failure Analysis by Combining Plasma FIB Milling and Laser Ablation
March 31, 2021	Introducing the New TESCAN TIMA G4 for Geosciences
April 7, 2021	SEM Large-volume Analysis in Life Sciences assisted by Serial Block-Face Imaging
April 14, 2021	Innovative FIB/SEM Lift-out Solutions for Advanced TEM Lamella Preparation Requirements
April 21, 2021	Leveraging Advanced UHR-SEM Contrast Methods Using TESCAN CLARA’s In-column Detectors
April 28, 2021	3D FIB/SEM Data Acquisition and Processing Solutions for Life Sciences

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- May 5, 2021 Introducing the New TESCAN TIMA G4 for Process Mineralogy
- May 12, 2021 Prepare Top-down, Inverted and Planar TEM lamella from Logic and Memory Devices
- May 19, 2021 CryoTEM Lamella Preparation from Biological Samples

For more information about the 2021 Spring Seminar Series and to register, visit:

<https://www.tescan.com/tescan-spring-seminar-series-2021/>.

About TESCAN

TESCAN enables nanoscale investigation and analysis within the geosciences, materials science, life sciences and semiconductor industries. The company has a 30-year history of developing innovative electron microscopy, micro-computed tomography, and related software solutions for customers in research and industry worldwide. As a result, TESCAN has earned a leading position in micro- and nanotechnology. For more information visit: www.tescan.com.

TESCAN ORSAY HOLDING was established in 2013 as a result of long-term expansion and establishment of subsidiaries worldwide, including France-based ORSAY PHYSICS, a world leader in customized focused ion and electron beam technology. TESCAN ORSAY HOLDING maintains its headquarters, production and R&D in Brno, Czech Republic. Every TESCAN microscope is expertly produced in Brno and shipped to customers worldwide.

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